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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I ² C, LINbus, SIO, SSU, UART/USART
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	47
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 12x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	52-LQFP
Supplier Device Package	52-LQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f2135ccnfp-30

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R8C/35C Group 1. Overview

Specifications for R8C/35C Group (2) Table 1.2

Item	Function	Specification
Serial	UART0, UART1	Clock synchronous serial I/O/UART × 2 channel
Interface	UART2	Clock synchronous serial I/O/UART, I ² C mode (I ² C-bus), multiprocessor communication function
Synchronous S	Serial	1 (shared with I ² C-bus)
Communication	n Unit (SSU)	
I ² C bus		1 (shared with SSU)
LIN Module		Hardware LIN: 1 (timer RA, UART0)
A/D Converter		10-bit resolution × 12 channels, includes sample and hold function, with sweep mode
D/A Converter		8-bit resolution x 2 circuits
Comparator B		2 circuits
Flash Memory		Programming and erasure voltage: VCC = 2.7 to 5.5 V
		Programming and erasure endurance: 10,000 times (data flash) 1,000 times (program BOM)
		1,000 times (program ROM)
		Program security: ROM code protect, ID code check Debug functions: On-chip debug, on-board flash rewrite function
		Background operation (BGO) function
Operating Fred Voltage	quency/Supply	f(XIN) = 20 MHz (VCC = 2.7 to 5.5 V) f(XIN) = 5 MHz (VCC = 1.8 to 5.5 V)
Current consu	mption	Typ. 6.5 mA (VCC = 5.0 V, f(XIN) = 20 MHz) Typ. 3.5 mA (VCC = 3.0 V, f(XIN) = 10 MHz) Typ. 3.5 μ A (VCC = 3.0 V, wait mode (f(XCIN) = 32 kHz)) Typ. 2.0 μ A (VCC = 3.0 V, stop mode)
	pient Temperature	-20 to 85°C (N version) -40 to 85°C (D version) (1)
Package		52-pin LQFP Package code: PLQP0052JA-A (previous code: 52P6A-A)

Note:
 1. Specify the D version if D version functions are to be used.

R8C/35C Group 1. Overview

1.4 Pin Assignment

Figure 1.3 shows the Pin Assignment (Top View). Tables 1.4 and 1.5 outline the Pin Name Information by Pin Number.

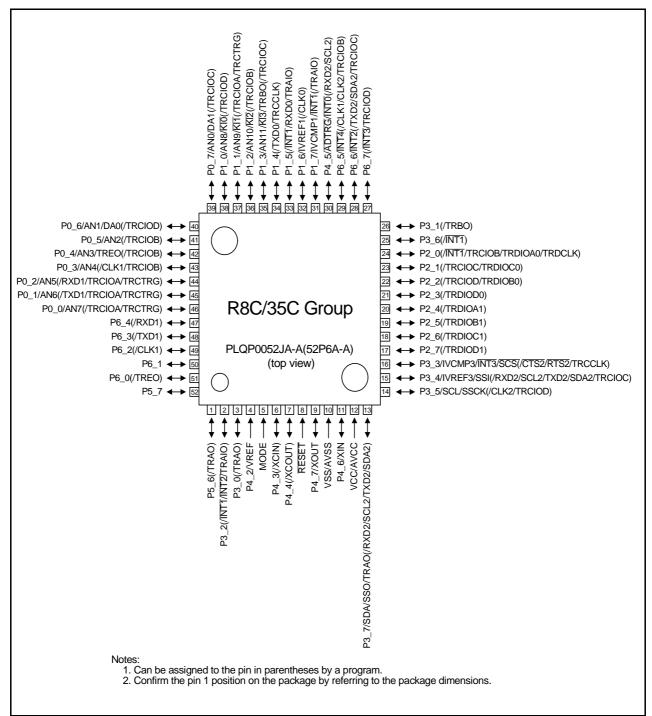


Figure 1.3 Pin Assignment (Top View)

R8C/35C Group 1. Overview

Table 1.4 Pin Name Information by Pin Number (1)

		I/O Pin Functions for Peripheral Modules							
Pin Number	Control Pin	Port	Interrupt	Timer	Serial Interface	SSU	I ² C bus	A/D Converter, D/A Converter, Comparator B	
1		P5_6		(TRAO)					
2		P3_2	(INT1/INT2)	(TRAIO)					
3		P3_0		(TRAO)					
4		P4_2						VREF	
5	MODE								
6	(XCIN)	P4_3							
7	(XCOUT)	P4_4							
8	RESET								
9	XOUT	P4_7							
10	VSS/AVSS								
11	XIN	P4_6							
12 13	VCC/AVCC	P3_7		TRAO	(RXD2/SCL2/ TXD2/SDA2)	SSO	SDA		
14		P3_5		(TRCIOD)	(CLK2)	SSCK	SCL		
15		P3_4		(TRCIOC)	(RXD2/SCL2/	SSI	002	IVREF3	
		_		(/	TXD2/SDA2)				
16		P3_3	ĪNT3	(TRCCLK)	(CTS2/RTS2)	SCS		IVCMP3	
17		P2_7		(TRDIOD1)					
18		P2_6		(TRDIOC1)					
19		P2_5		(TRDIOB1)					
20		P2_4		(TRDIOA1)					
21		P2_3		(TRDIOD0)					
22		P2_2		(TRCIOD/ TRDIOB0)					
23		P2_1		(TRCIOC/ TRDIOC0)					
24		P2_0	(ĪNT1)	(TRCIOB/ TRDIOA0/ TRDCLK)					
25		P3_6	(INT1)						
26		P3_1		(TRBO)					
27		P6_7	(INT3)	(TRCIOD)					
28		P6_6	INT2	(TRCIOC)	(TXD2/SDA2)				
29		P6_5	ĪNT4	(TRCIOB)	(CLK1/CLK2)				
30		P4_5	ĪNT0		(RXD2/SCL2)			ADTRG	
31		P1_7	ĪNT1	(TRAIO)				IVCMP1	
32		P1_6			(CLK0)			IVREF1	
33		P1_5	(INT1)	(TRAIO)	(RXD0)				
34		P1_4		(TRCCLK)	(TXD0)				
35		P1_3	KI3	TRBO (/TRCIOC)				AN11	

Note:

1. Can be assigned to the pin in parentheses by a program.

R8C/35C Group 1. Overview

Table 1.7 Pin Functions (2)

Item	Pin Name	I/O Type	Description
Reference voltage input	VREF	I	Reference voltage input pin to A/D converter and D/A converter
A/D converter	AN0 to AN11	I	Analog input pins to A/D converter
	ADTRG	I	A/D external trigger input pin
D/A converter	DA0, DA1	0	D/A converter output pins
Comparator B	IVCMP1, IVCMP3	I	Comparator B analog voltage input pins
	IVREF1, IVREF3	I	Comparator B reference voltage input pins
I/O port	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_3 to P4_7, P5_6, P5_7, P6_0 to P6_7	I/O	CMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. All ports can be used as LED drive ports.
Input port	P4_2	I	Input-only port

I: Input O: Output

I/O: Input and output

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.

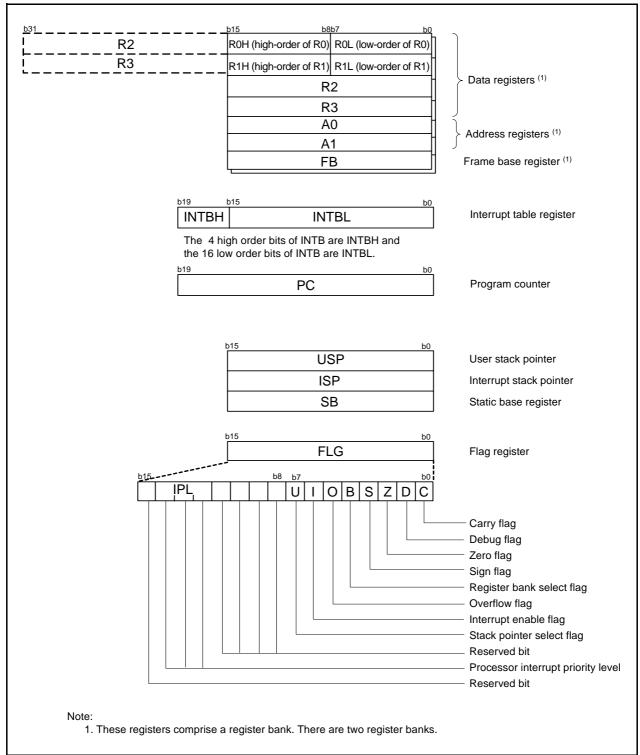


Figure 2.1 CPU Registers

2.8.7 Interrupt Enable Flag (I)

The I flag enables maskable interrupts.

Interrupts are disabled when the I flag is set to 0, and are enabled when the I flag is set to 1. The I flag is set to 0 when an interrupt request is acknowledged.

2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to 0; USP is selected when the U flag is set to 1.

The U flag is set to 0 when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL is 3 bits wide and assigns processor interrupt priority levels from level 0 to level 7. If a requested interrupt has higher priority than IPL, the interrupt is enabled.

2.8.10 Reserved Bit

If necessary, set to 0. When read, the content is undefined.



SFR Information (5) (1) Table 4.5

Address	Register	Symbol	After Reset
0100h	Timer RA Control Register	TRACR	00h
0100h	Timer RA I/O Control Register	TRAIOC	
			00h
0102h	Timer RA Mode Register	TRAMR	00h
0103h	Timer RA Prescaler Register	TRAPRE	FFh
0104h	Timer RA Register	TRA	FFh
0105h	LIN Control Register 2	LINCR2	00h
0106h	LIN Control Register	LINCR	00h
0107h	LIN Status Register	LINST	00h
0108h	Timer RB Control Register	TRBCR	00h
0109h	Timer RB One-Shot Control Register	TRBOCR	00h
010Ah	Timer RB I/O Control Register	TRBIOC	00h
010Bh	Timer RB Mode Register	TRBMR	00h
010Ch	Timer RB Prescaler Register	TRBPRE	FFh
010Ch	Timer RB Secondary Register	TRBSC	
			FFh
010Eh	Timer RB Primary Register	TRBPR	FFh
010Fh			
0110h			
0111h			
0112h			
0113h			
0114h		<u> </u>	†
0115h			+
0116h		1	+
0117h			
	Times DE Coond Data Register / Countar Data Register	TRESEC	006
0118h	Timer RE Second Data Register / Counter Data Register		00h
0119h	Timer RE Minute Data Register / Compare Data Register	TREMIN	00h
011Ah	Timer RE Hour Data Register	TREHR	00h
011Bh	Timer RE Day of Week Data Register	TREWK	00h
011Ch	Timer RE Control Register 1	TRECR1	00h
011Dh	Timer RE Control Register 2	TRECR2	00h
011Eh	Timer RE Count Source Select Register	TRECSR	00001000b
011Fh	<u> </u>		
0120h	Timer RC Mode Register	TRCMR	01001000b
0121h	Timer RC Control Register 1	TRCCR1	00h
0121h	Timer RC Interrupt Enable Register	TRCIER	01110000b
0122h	Timer RC Status Register		01110000b
		TRCSR	
0124h	Timer RC I/O Control Register 0	TRCIOR0	10001000b
0125h	Timer RC I/O Control Register 1	TRCIOR1	10001000b
0126h	Timer RC Counter	TRC	00h
0127h			00h
0128h	Timer RC General Register A	TRCGRA	FFh
0129h			FFh
012Ah	Timer RC General Register B	TRCGRB	FFh
012Bh			FFh
012Ch	Timer RC General Register C	TRCGRC	FFh
012Dh	Times 110 Control (Cognition Co		FFh
	Timor PC Conoral Pagistor D	TDCCDD	FFh
012Eh	Timer RC General Register D	TRCGRD	
012Fh		TDOODO	FFh
0130h	Timer RC Control Register 2	TRCCR2	00011000b
0131h	Timer RC Digital Filter Function Select Register	TRCDF	00h
0132h	Timer RC Output Master Enable Register	TRCOER	01111111b
0133h	Timer RC Trigger Control Register	TRCADCR	00h
0134h			
0135h	Timer RD Control Expansion Register	TRDECR	00h
0136h	Timer RD Trigger Control Register	TRDADCR	00h
0137h	Timer RD Start Register	TRDSTR	11111100b
0138h	Timer RD Mode Register	TRDMR	00001110b
	Timer RD PWM Mode Register		
0139h		TRDPMR	10001000b
013Ah	Timer RD Function Control Register	TRDFCR	10000000b
013Bh	Timer RD Output Master Enable Register 1	TRDOER1	FFh
013Ch	Timer RD Output Master Enable Register 2	TRDOER2	01111111b
	T	TRDOCR	00h
013Dh	Timer RD Output Control Register		0011
013Dh 013Eh	Timer RD Output Control Register Timer RD Digital Filter Function Select Register 0	TRDDF0	00h

Note:

1. The blank areas are reserved and cannot be accessed by users.

SFR Information (8) (1) Table 4.8

Address	Register	Symbol	After Reset
01C0h	Address Match Interrupt Register 0	RMAD0	XXh
01C1h			XXh
01C2h			0000XXXXb
01C3h	Address Match Interrupt Enable Register 0	AIER0	00h
01C4h	Address Match Interrupt Register 1	RMAD1	XXh
01C5h			XXh
01C6h			0000XXXXb
01C7h	Address Match Interrupt Enable Register 1	AIER1	00h
01C8h			
01C9h			
01CAh			
01CBh			
01CCh			
01CDh			
01CEh			
01CFh			
01D0h			
01D1h			
01D2h			
01D3h	 	 	
01D4h	+		
01D5h	 	 	
01D6h			
01D7h			
01D8h			
01D9h			
01DAh	+		
01DRh			
01DCh	+		
01DDh			
01DBh			
01DEII			
01E0h	Pull-Up Control Register 0	PUR0	00b
01E0II	Pull-Up Control Register 1		00h
01E1fi	Pull-Op Control Register 1	PUR1	00h
01E3h			
01E4h			
01E5h			
01E6h			
01E7h			
01E8h			
01E9h			
01EAh			
01EBh			
01ECh			
01EDh			
01EEh			
01EFh			
01F0h	Port P1 Drive Capacity Control Register	P1DRR	00h
01F1h	Port P2 Drive Capacity Control Register	P2DRR	00h
01F2h	Drive Capacity Control Register 0	DRR0	00h
01F3h	Drive Capacity Control Register 1	DRR1	00h
01F4h			
01F5h	Input Threshold Control Register 0	VLT0	00h
01F6h	Input Threshold Control Register 1	VLT1	00h
01F7h			
01F8h	Comparator B Control Register 0	INTCMP	00h
011 011	† · · · · · · · · · · · · · · · · · · ·		
01F9h		INTEN	00h
01F9h	External Input Enable Register 0		
01F9h 01FAh	External Input Enable Register 0 External Input Enable Register 1		00h
01F9h 01FAh 01FBh	External Input Enable Register 1	INTEN1	00h
01F9h 01FAh 01FBh 01FCh	External Input Enable Register 1 INT Input Filter Select Register 0	INTEN1 INTF	00h 00h
01F9h 01FAh 01FBh	External Input Enable Register 1	INTEN1	00h

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

SFR Information (10) ⁽¹⁾ **Table 4.10**

Address	Register	Symbol	After Reset
2C70h	DTC Control Data 6	DTCD6	XXh
2C71h	DTO CONTO Data o	B1680	XXh
2C72h	-		XXh
2C73h	-		XXh
2C73h	-		XXh
2C7411	-		XXh
2C76h	-		XXh
	4		XXh
2C77h 2C78h	DTC Control Data 7	DTCD7	XXh
	DTC Control Data 7	ысы	
2C79h	4		XXh
2C7Ah			XXh
2C7Bh			XXh
2C7Ch			XXh
2C7Dh			XXh
2C7Eh			XXh
2C7Fh			XXh
2C80h	DTC Control Data 8	DTCD8	XXh
2C81h			XXh
2C82h			XXh
2C83h			XXh
2C84h			XXh
2C85h			XXh
2C86h			XXh
2C87h			XXh
2C88h	DTC Control Data 9	DTCD9	XXh
2C89h			XXh
2C8Ah			XXh
2C8Bh			XXh
2C8Ch			XXh
2C8Dh			XXh
2C8Eh			XXh
2C8Fh			XXh
2C90h	DTC Control Data 10	DTCD10	XXh
2C91h			XXh
2C92h	1		XXh
2C93h	†		XXh
2C94h	†		XXh
2C95h	†		XXh
2C96h	1		XXh
2C97h	-		XXh
2C98h	DTC Control Data 11	DTCD11	XXh
2C99h	DTC Control Bata 11	BIGBII	XXh
2C9Ah	-		XXh
2C9An	-		XXh
2C9Bn	-		XXh
2C9Ch	-		XXh
	-		XXh
2C9Eh	4		
2C9Fh	DTC Control Data 12	DTCD42	XXh
2CA0h	DTC Control Data 12	DTCD12	XXh
2CA1h	-		XXh
2CA2h			XXh
2CA3h			XXh
2CA4h			XXh
2CA5h			XXh
2CA6h			XXh
2CA7h			XXh
2CA8h	DTC Control Data 13	DTCD13	XXh
2CA9h			XXh
2CAAh	1		XXh
2CABh	1		XXh
2CACh	1		XXh
2CADh	1		XXh
2CAEh	1		XXh
2CAFh	1		XXh
Y: Undefined	1		1,000

X: Undefined
Note:

1. The blank areas are reserved and cannot be accessed by users.

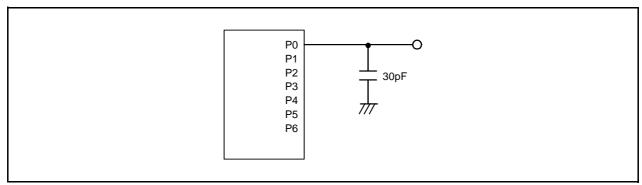


Figure 5.1 Ports P0 to P6 Timing Measurement Circuit

Table 5.3 A/D Converter Characteristics

Symbol	Parameter		Cons	ditions		Standard	ı	Unit
Symbol	Farameter		Conc	Conditions		Тур.	Max.	Offic
=	Resolution		Vref = AVCC		-	-	10	Bit
_	Absolute accuracy	10-bit mode	Vref = AVCC = 5.0 V	AN0 to AN7 input, AN8 to AN11 input	-	_	±3	LSB
			Vref = AVCC = 3.3 V	AN0 to AN7 input, AN8 to AN11 input	_	-	±5	LSB
			Vref = AVCC = 3.0 V	AN0 to AN7 input, AN8 to AN11 input	=	=	±5	LSB
			Vref = AVCC = 2.2 V	AN0 to AN7 input, AN8 to AN11 input	_	_	±5	LSB
		8-bit mode	Vref = AVCC = 5.0 V	AN0 to AN7 input, AN8 to AN11 input	_	_	±2	LSB
			Vref = AVCC = 3.3 V	AN0 to AN7 input, AN8 to AN11 input	-	_	±2	LSB
			Vref = AVCC = 3.0 V	AN0 to AN7 input, AN8 to AN11 input	-	-	±2	LSB
			Vref = AVCC = 2.2 V	AN0 to AN7 input, AN8 to AN11 input	-	_	±2	LSB
φAD	A/D conversion clock	A/D conversion clock		5.5 V ⁽²⁾	2	=	20	MHz
			$3.2 \text{ V} \leq \text{Vref} = \text{AVcc} \leq 5.5 \text{ V}$ (2)		2	=	16	MHz
			$2.7 \text{ V} \leq \text{Vref} = \text{AVcc} \leq 5.5 \text{ V}$ (2)		2	-	10	MHz
			2.2 V ≤ Vref = AVCC ≤ 5.5 V (2)		2	-	5	MHz
_	Tolerance level impedance	Э			_	3	_	kΩ
tconv	Conversion time	10-bit mode	Vref = AVCC = 5.0 V, (AD = 20 MHz	2.2	-	_	μS
		8-bit mode	Vref = AVCC = 5.0 V, (AD = 20 MHz	2.2	=	-	μS
tsamp	Sampling time		φAD = 20 MHz		8.0	_	_	μS
lVref	Vref current		Vcc = 5 V, XIN = f1 = φAD = 20 MHz		-	45	_	μА
Vref	Reference voltage		2.2	_	AVcc	V		
VIA	Analog input voltage (3)				0	-	Vref	V
OCVREF	On-chip reference voltage		2 MHz ≤ φAD ≤ 4 MH	lz	1.19	1.34	1.49	V

Notes:

^{1.} Vcc/AVcc = Vref = 2.2 to 5.5 V, Vss = 0 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.

^{2.} The A/D conversion result will be undefined in wait mode, stop mode, when the flash memory stops, and in low-current-consumption mode. Do not perform A/D conversion in these states or transition to these states during A/D conversion.

^{3.} When the analog input voltage is over the reference voltage, the A/D conversion result will be 3FFh in 10-bit mode and FFh in 8-bit mode.

Cumbal	Parameter	Condition		Lloit		
Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Vdet2	Voltage detection level Vdet2_0	At the falling of Vcc	3.70	4.00	4.30	V
_	Hysteresis width at the rising of Vcc in voltage detection 2 circuit		-	0.10	-	V
_	Voltage detection 2 circuit response time (2)	At the falling of Vcc from 5 V to (Vdet2_0 - 0.1) V	-	20	150	μS
_	Voltage detection circuit self power consumption	VCA27 = 1, Vcc = 5.0 V	_	1.7	_	μА
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		-	_	100	μS

Notes:

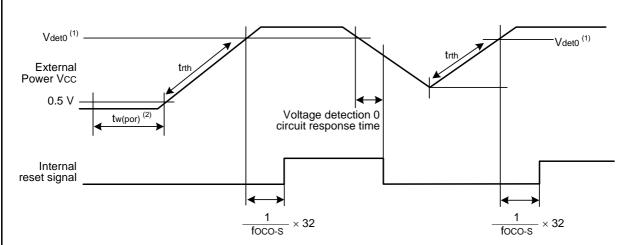
- 1. The measurement condition is Vcc = 1.8 V to 5.5 V and $T_{opr} = -20$ to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version).
- 2. Time until the voltage monitor 2 interrupt request is generated after the voltage passes Vdet2.
- 3. Necessary time until the voltage detection circuit operates after setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.

Table 5.11 Power-on Reset Circuit (2)

Symbol	Parameter	Condition		Unit		
	Falamete	Condition	Min.	Тур.	Max.	Offic
trth	External power Vcc rise gradient	(1)	0	_	50,000	mV/msec

Notes:

- 1. The measurement condition is Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.
- 2. To use the power-on reset function, enable voltage monitor 0 reset by setting the LVDAS bit in the OFS register to 0.



Notes:

- Vdeto indicates the voltage detection level of the voltage detection 0 circuit. Refer to 6. Voltage Detection Circuit of User's Manual: Hardware (REJ09B0567) for details.
- 2. tw(por) indicates the duration the external power Vcc must be held below the valid voltage (0.5 V) to enable a power-on reset. When turning on the power after it falls with voltage monitor 0 reset disabled, maintain tw(por) for 1 ms or more.

Figure 5.3 Power-on Reset Circuit Electrical Characteristics

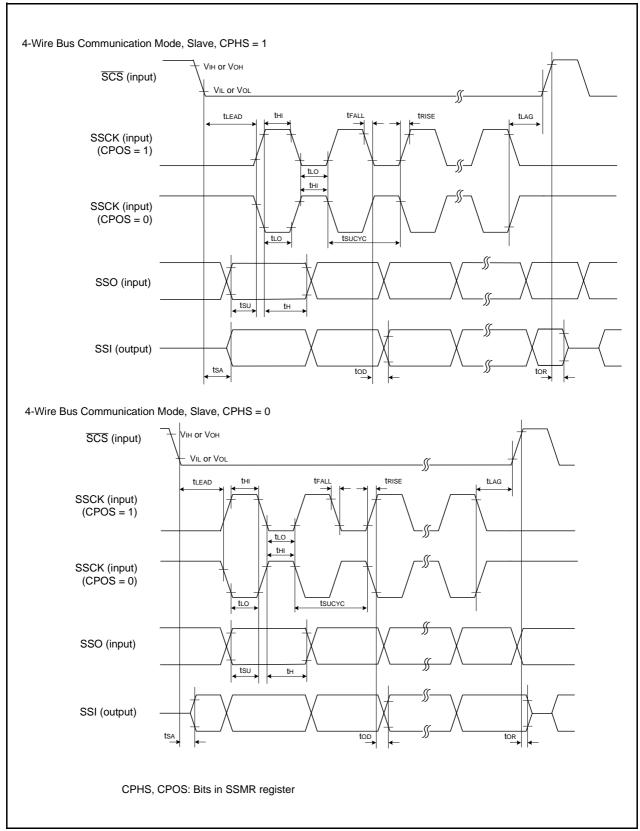


Figure 5.5 I/O Timing of Synchronous Serial Communication Unit (SSU) (Slave)

Table 5.18 Electrical Characteristics (2) [3.3 V \leq Vcc \leq 5.5 V] (Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter		Condition	Min.	Standard Typ.	Max.	Unit
Icc	Power supply current (Vcc = 3.3 to 5.5 V)	High-speed clock mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	6.5	15	mA
	Single-chip mode, output pins are open, other pins		XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	=	5.3	12.5	mA
	are Vss		XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	3.6		mA
			XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	3.0	ı	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	2.2		mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	1.5		mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz No division	_	7.0	15	mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	3.0		mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 4 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-16, MSTIIC = MSTTRD = MSTTRC = 1	=	1		mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR27 = 1, VCA20 = 0	-	90	400	μА
		Low-speed clock mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz No division, FMR27 = 1, VCA20 = 0	-	85	400	μΑ
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz No division, Program operation on RAM Flash memory off, FMSTP = 1, VCA20 = 0	-	47		μА
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	-	15	100	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	_	4	90	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (peripheral clock off) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	-	3.5	-	μА
		Stop mode	XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1, Peripheral clock off VCA27 = VCA26 = VCA25 = 0	-	2.0	5.0	μА
			XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1, Peripheral clock off VCA27 = VCA26 = VCA25 = 0	-	5.0 ⁽¹⁾	-	μА

Notes:

- 1. Value when the program ROM capacity of the product is 16 Kbytes to 32 Kbytes.
- 2. Value when the program ROM capacity of the product is 48 Kbytes to 128 Kbytes.

Table 5.23 Electrical Characteristics (3) [2.7 V \leq Vcc < 4.2 V]

Symbol	Parameter		Condition		Standard			Unit
Syllibol					Min.	Тур.	Max.	Unit
Vон	Output "H" voltage	Other than XOUT	Drive capacity High	Iон = −5 mA	Vcc - 0.5	1	Vcc	V
			Drive capacity Low	Iон = −1 mA	Vcc - 0.5	-	Vcc	V
		XOUT		IOH = -200 μA	1.0	-	Vcc	V
Vol	Output "L" voltage	Other than XOUT	Drive capacity High	IoL = 5 mA	_	-	0.5	V
			Drive capacity Low	IoL = 1 mA	_	-	0.5	V
		XOUT		IoL = 200 μA	=	-	0.5	V
VT+-VT-	Hysteresis	INTO, INT1, INT2, INT3, INT4, KIO, KI1, KI2, KI3, TRAIO, TRBO, TRCIOA, TRCIOB, TRCIOC, TRDIOAO, TRDIOCO, TRCTRG, TRCCLK, ADTRG, RXDO, RXD1, RXD2, CLKO, CLK1, CLK2, SSI, SCL, SDA, SSO	Vcc = 3.0 V		0.1	0.4	_	V
Іін	Input "H" current		VI = 3 V, Vcc = 3.0 V		=	_	4.0	μА
lıL	Input "L" current		VI = 0 V, Vcc = 3.0 V	/	-	-	-4.0	μ A
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 3.0 V		42	84	168	kΩ
RfXIN	Feedback resistance	XIN			=	0.3	_	ΜΩ
RfXCIN	Feedback resistance	XCIN			=	8	_	ΜΩ
VRAM	RAM hold voltage		During stop mode		1.8	1	_	V

Note:

^{1.} $2.7 \text{ V} \le \text{Vcc} < 4.2 \text{ V}$ and $\text{Topr} = -20 \text{ to } 85^{\circ}\text{C}$ (N version) / $-40 \text{ to } 85^{\circ}\text{C}$ (D version), f(XIN) = 10 MHz, unless otherwise specified.

Timing Requirements

(Unless Otherwise Specified: Vcc = 3 V, Vss = 0 V at Topr = 25°C)

Table 5.25 External Clock Input (XOUT, XCIN)

Symbol	Parameter		Standard		
			Max.	Unit	
tc(XOUT)	XOUT input cycle time	50	-	ns	
twh(xout)	XOUT input "H" width	24	-	ns	
twl(xout)	XOUT input "L" width	24	-	ns	
tc(XCIN)	XCIN input cycle time	14	-	μS	
twh(xcin)	XCIN input "H" width	7	-	μS	
tWL(XCIN)	XCIN input "L" width 7 –			μS	

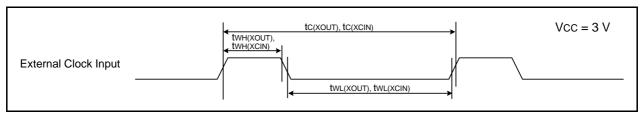


Figure 5.12 External Clock Input Timing Diagram when VCC = 3 V

Table 5.26 TRAIO Input

Symbol	Parameter		Standard		
Symbol			Max.	Unit	
tc(TRAIO)	TRAIO input cycle time	-	ns		
twh(traio)	TRAIO input "H" width 120 –				
twl(traio)	TRAIO input "L" width 120 –				

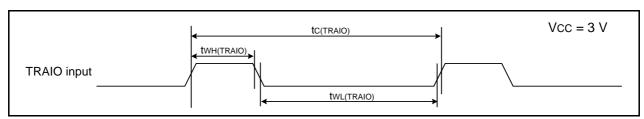


Figure 5.13 TRAIO Input Timing Diagram when Vcc = 3 V

Table 5.29 Electrical Characteristics (5) [1.8 $V \le Vcc < 2.7 V$]

Symbol	Parameter		Condition		Standard			Unit
Symbol					Min.	Тур.	Max.	Unit
Vон	Output "H" voltage	Other than XOUT	Drive capacity High	Iон = −2 mA	Vcc - 0.5	1	Vcc	V
			Drive capacity Low	Iон = −1 mA	Vcc - 0.5	-	Vcc	V
		XOUT		$IOH = -200 \mu A$	1.0	-	Vcc	V
Vol	Output "L" voltage	Other than XOUT	Drive capacity High	IoL = 2 mA	-	-	0.5	V
			Drive capacity Low	IoL = 1 mA	-	-	0.5	V
		XOUT		IoL = 200 μA	-	-	0.5	V
VT+-VT-	Hysteresis	INTO, INT1, INT2, INT3, INT4, KIO, KI1, KI2, KI3, TRAIO, TRBO, TRCIOA, TRCIOB, TRCIOC, TRCIOD, TRDIOAO, TRDIOBO, TRDIOCO, TRDIOBO, TRDIOCO, TRDIOBI, TRDIOC1, TRDIOD1, TRCTRG, TRCCLK, ADTRG, RXD0, RXD1, RXD2, CLK0, CLK1, CLK2, SSI, SCL, SDA, SSO RESET			0.05	0.20	_	V
lін	Input "H" current		VI = 2.2 V, Vcc = 2.2	! V	-	-	4.0	μΑ
lıL	Input "L" current		VI = 0 V, Vcc = 2.2 V	/	-	-	-4.0	μΑ
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 2.2 V	/	70	140	300	kΩ
RfXIN	Feedback resistance	XIN			-	0.3	_	МΩ
RfXCIN	Feedback resistance	XCIN			-	8	-	МΩ
VRAM	RAM hold voltage		During stop mode		1.8	-	-	V

Note:

^{1.} $1.8 \text{ V} \le \text{Vcc} < 2.7 \text{ V}$ and $\text{Topr} = -20 \text{ to } 85^{\circ}\text{C}$ (N version) / -40 to 85°C (D version), f(XIN) = 5 MHz, unless otherwise specified.

REVISION HISTORY	R8C/35C Group Datasheet
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Rev.	Date	Description		
Nev.		Page	Summary	
0.10	Sep. 01, 2009	_	First Edition issued	
1.00	Aug. 24, 2010	All	"Preliminary" and "Under development" deleted	
		4	Table1.3 revised	
		27 to 53	5. Electrical Characteristics added	

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General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

 The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

— When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

— The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.

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